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**EXHIBIT A**

Additional Restrictions on Licensed Materials

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The Licensed Materials may include the DeVaSys driver software. The DeVaSys driver software may only be used with DeVaSys products.

**Total Phase, Inc. owned software:**

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The Licensed Materials may include I2C Tools USB-to-I2C Pro driver software. The I2C Tools USB-to-I2C Pro driver software may only be used with hardware provided by SB Solutions, Inc.

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